

Revision History

Rev.No.	Description of revision	Date	Approved by	Checked by	Issued by
00	First Edition	Jun.9,2022	W. Muraoka	F. Horie	Y. Kikuchi

【Part Number list】

Nominal Frequency (MHz) (*1)	KYOCERA Part Number	ESR (Ω) (*2)	Nominal Frequency Code (*3)
24.000	CX2016SA24000D0FLJG1	150	24000
24.576	CX2016SA24576D0FLJG1	150	24576
25.000	CX2016SA25000D0FLJG1	150	25000
26.000	CX2016SA26000D0FLJG1	60	26000
27.000	CX2016SA27000D0FLJG1	60	27000
27.120	CX2016SA27120D0FLJG1	60	27120
30.000	CX2016SA30000D0FLJG1	60	30000
32.000	CX2016SA32000D0FLJG1	60	32000
38.400	CX2016SA38400D0FLJG1	60	38400
40.000	CX2016SA40000D0FLJG1	50	40000
48.000	CX2016SA48000D0FLJG1	50	48000
54.000	CX2016SA54000D0FLJG1	50	54000

1. APPLICATION

This specification sheet is applied to CX2016SA quartz crystal

2. KYOCERA PART NUMBER

Refer to Doc No. UKY1C-H1-22354-00 Page 3/12

3. RATINGS

Items	SYMB.	Rating	Unit	Remarks
Operating Temperature Range	Topr	-30 to +85	°C	
Storage Temperature Range	Tstg	-40 to +125	°C	

4. CHARACTERISTICS

ELECTRICAL CHARACTERISTICS

Items	Electrical Specification					Test Condition	Remarks
	SYMB.	Min	Typ.	Max	Unit		
Mode of Vibration		Fundamental					
Nominal Frequency	F0		(*1)		MHz		
Nominal Temperature	T _{NOM}		+25		°C		
Load Capacitance	CL	8.0			pF		
Frequency Tolerance	df/F	-10.0		+10.0	PPM	+25±3°C	Based on an oscillation frequency at +25 °C
Frequency Temperature Characteristics	df/F	-15.0		+15.0		-30 to +85°C	
Frequency Aging Rate		-2.0		+2.0		1 st year	
Equivalent Series Resistance	ESR		(*2)		Ω		
Drive Level	Pd	0.01		200	μW		
Insulation Resistance	IR	500			MΩ	100V(DC)	

*1 *2 Refer to Doc No. UKY1C-H1-22354-00 Page 3/12

5. Measurement Condition

5.1 Frequency measurement

Measuring instrument : IEC PI-Network Test Fixture

Load Capacitance : 8.0pF

Drive Level : 10 μ W

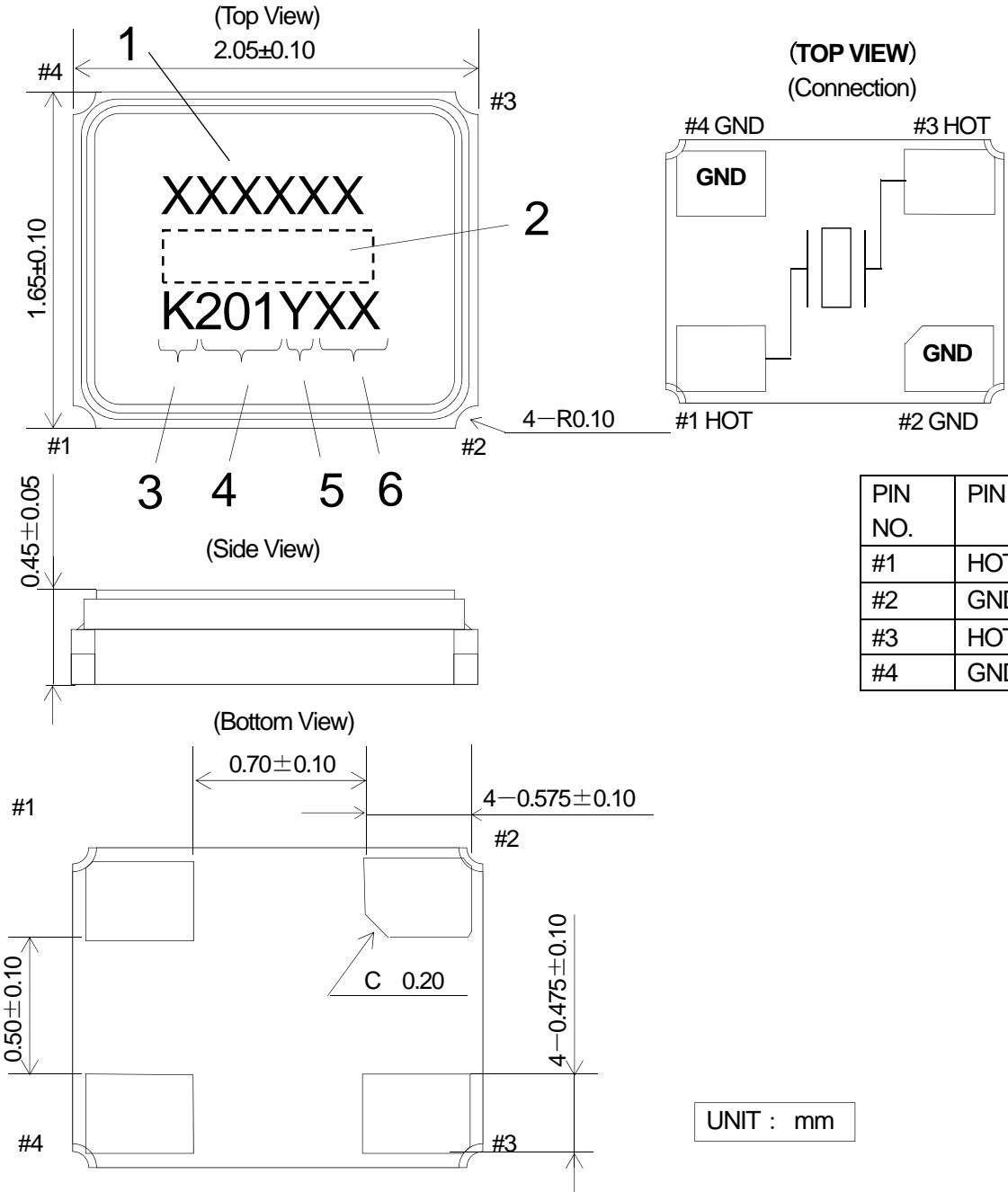
5.2 Equivalent series resistance (ESR) measurement

Measuring instrument : IEC PI-Network Test Fixture

Load Capacitance : Series

Drive Level : 10 μ W

6. APPEARANCES, DIMENSIONS
OUTLINE DIMENSION (not to scale)



PIN NO.	PIN Layout
#1	HOT
#2	GND
#3	HOT
#4	GND

UNIT : mm

MARKING

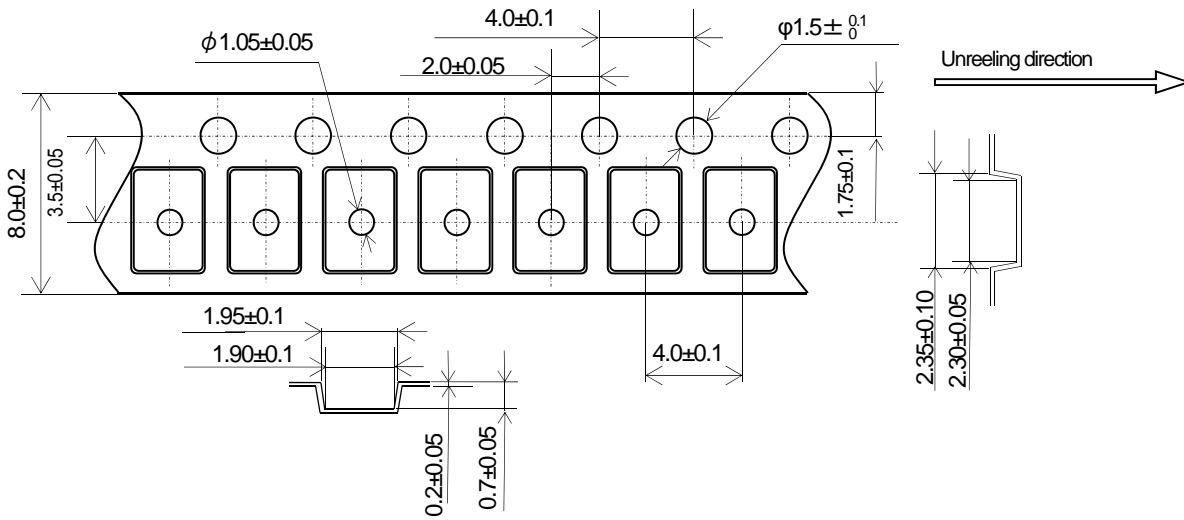
- 1. Serial Code 6Digits
- 2. Nominal Frequency First 5digit of the frequency is indicated. *4
- 3. Identification [K] is to indicate 1Pin direction.
- 4. Date Code Last 1 Digit of YEAR and WEEK (Ex) 2022,Jan,01 → 201
- 5. Manufacturing Location
 - Y...Japan (Yamagata)
 - Z...Japan (Shiga Yohkaichi)
 - V...Vietnam
- 6. Internal code

※The font of marking is for reference only.

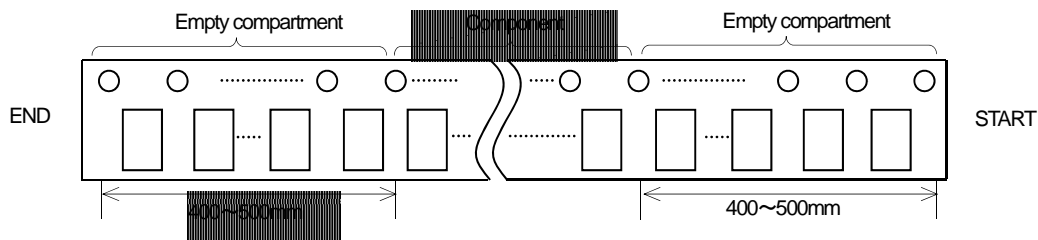
*3 Refer to Doc No. UKY1C-H1-22354-00 Page 3/12

8. TAPING&REEL

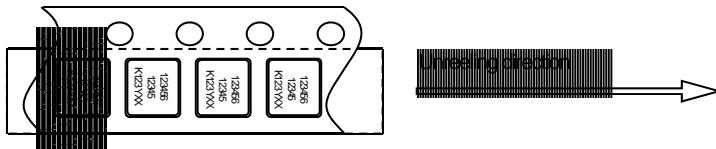
8-1.Dimensions



8-2.Leader and trailer tape

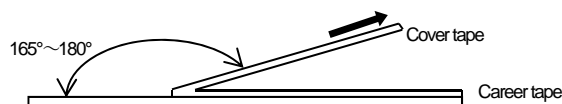


8-3.Direction (The direction shall be seen from the top cover tape side)



8-4.Specification

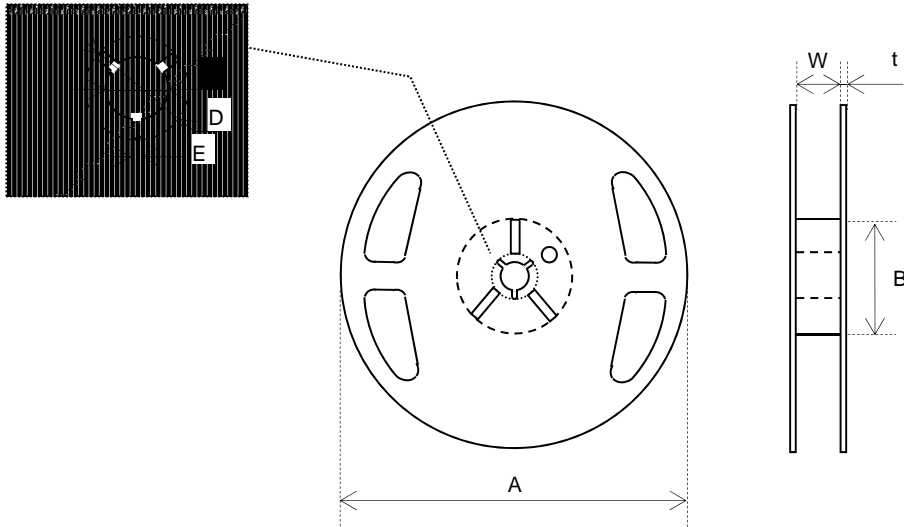
1. Material of the carrier tape is either polystyrene or A-PET (ESD).
2. Material of the cover tape is polyester (ESD).
3. The seal tape shall not cover the sprocket holes and not protrude from the carrier tape.
4. Tensile strength of carrier tape: 10N or more.
5. The R of the corner of each cavity is $0.2R_{MAX}$.
6. The alignment between centers of the cavity and sprocket hole shall be 0.05mm or less.
7. The orientation shall be checked from the top cover tape side as shown in 8-3.
8. Peeling force of cover tape: 0.1 to 1.0N.
9. The component will fall out naturally when cover tape is removed and set upside down.



KYOCERA Corporation

KBS-5079J

8-5.Reel Specification



φ180 Reel (3,000pcs Max)

Symbol	A	B	C	D
Dimension	φ180 +0/-3	φ60 +1/-0	φ13±0.2	φ21±0.8
Symbol	E	W	t	
Dimension	2.0±0.5	9±1	2.0±0.5	

(Unit : mm)

φ330 Reel (15,000pcs Max)

Symbol	A	B	C	D
Dimension	φ330±2.0	φ100±1.0	φ13±0.2	φ21±0.8
Symbol	E	W	t	
Dimension	2.0±0.5	9.5±0.5	2.2±0.1	

(Unit : mm)

9. ENVIRONMENTAL AND MECHANICAL CHARACTERISTICS :

(Reference: AEC-Q200 Rev. D. The solder used by examination is hereafter set to Sn-3Ag-0.5Cu.)

After following test, frequency shall not change more than $\pm 10 \times 10^{-6}$ and CI, $\pm 20\%$ or 5Ω .

No	Stress	Reference	Additional Requirements
9.1	High Temperature Exposure (Storage)	MIL-STD-202 Method 108	1000 hrs. at rated operating temperature (e.g. 85°C part can be stored for 1000 hrs at 85°C. Same applies for 125°C). Unpowered. Measurement at 24±4 hours after test conclusion.
9.2	Temperature Cycling	JESD22 Method JA-104	1000 cycles (-40°C to 125°C) Note: If 85°C part the 1000 cycles will be at that temperature rating. Measurement at 24±4 hours after test conclusion. 30min maximum dwell time at each temperature extreme. 1 min. maximum transition time.
9.3	Biased Humidity	MIL-STD-202 Method 103	1000 hours 85°C/85%RH. Rated VDD applied with 1 MW and inverter in parallel, 2X crystal CL capacitors between each crystal leg and GND. Measurement at 24±4 hours after test conclusion.
9.4	Operational Life	MIL-STD-202 Method 108	Note: 1000 hrs @ 125°C. If 85°C part will be tested at that temperature. Rated VDD applied with 1 MW and inverter in parallel, 2X crystal CL capacitors between each crystal leg and GND. Measurement at 24±4 hours after test conclusion.
9.5	Terminal Strength (Leaded)	MIL-STD-202 Method 211	Test leaded device lead integrity only. Conditions: A (227 g), C (227 g).
9.6	Resistance to Solvents	MIL-STD-202 Method 215	Note: Also aqueous wash chemical - OKEM clean or equivalent. Do not use banned solvents.
9.7	Mechanical Shock	MIL-STD-202 Method 213	Figure 1 of Method 213. Condition C
9.8	Vibration	MIL-STD-202 Method 204	5g's for 20 minutes 12 cycles each of 3 orientations. Note: Use 8"X5" PCB .031" thick with 7 secure points on one 8" side and 2 secure points on corners of opposite sides. Parts mounted within 2" from any secure point. Test from 10-2000 Hz.
9.9	Resistance to Soldering Heat	MIL-STD-202 Method 210	Condition B No pre-heat of samples. Note: Single Wave solder - Procedure 1 with solder within 1.5 mm of device body for Leaded. Procedure 1 except 230°C and immerse only to level to cover terminals for SMD.
9.10	Solder ability	J-STD-002	For both Leaded & SMD. Electrical Test not required. Magnification 50 X. Conditions: Leaded: Method A @ 235°C, category 3. SMD: a) Method B, 4 hrs @ 155°C dry heat @ 235°C b) Method B @ 215°C category 3. c) Method D category 3 @ 260°C.
9.11	Flammability	UL-94	V-0 or V-1 Acceptable
9.12	Board Flex	AEC Q200-005	60 sec minimum holding time.
9.13	Terminal Strength(SMD)	AEC Q200-006	-

14. Quality Assurance

To be guaranteed by Kyocera Corporation Yamagata Higashine Plant Quality Assurance Division

15. Quality guarantee

In case when Kyocera Corporation rooted failure occurred within 1year after its delivery, substitute product will be arranged based on discussion. Quality guarantee of product after 1year of its delivery is waived.

16. Others

In case of any questions or opinions regarding the Specification, please have it in written manner within 45 days after issued date.

单击下面可查看定价，库存，交付和生命周期等信息

[>>Kyocera\(京瓷\)](#)